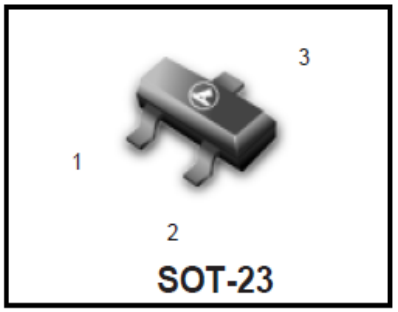
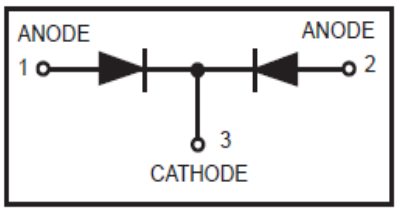
DUAL SERIES SCHOTTKY BARRIER DIODE

LBAT54CLT1G
S-LBAT54CLT1G

These Schottky barrier diodes are designed for high speed applications, circuit protection, and voltage clamping. low forward voltage reduces conduction loss. Miniature package is excellent for hand held and portable applications space is limited.





●FEATURES

1)Extremely Fast Switching Speed
2) Low Forward Voltage — 0.35 Volts (Typ) @ I_F = 10 mAdc
3)We declare that the material of product compliant with RoHS requirements and Halogen Free.
4)S- Prefix for automotive and other applications requiring unique site and control change requirements; AEC-Q101 qualified and PPAP capable.

●DEVICE MARKING AND ORDERING INFORMATION

Device	Marking	Shipping
LBAT54CLT1G	5C	3000/Tape&Reel
LBAT54CLT3G	5C	10000/Tape&Reel

●MAXIMUM RATINGS(Ta = 25℃)

Rating	Symbol	Limits	Unit
DC reverse voltage	V_R	30	V
Forward Power Dissipation @T_A = 25°C Derate above 25°C	P_F	 225 1.8	 mW mW/°C
DC forward current	I_F	200Max	mA
Junction temperature	T_J	125Max	℃
Storage temperature	Tstg	−55～+150	℃

●ELECTRICAL CHARACTERISTICS (Ta= 25℃)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Reverse Breakdown Voltage	$V_{(BR)R}$	30	–	–	V	I_R = 10 μA
Total Capacitance	C_T	–	–	10	pF	V_R = 1.0 V, f = 1.0 MHz
Reverse current	I_R	–	0.5	2	μA	V_R=25V
Forward voltage	V_F	–	0.22	0.24	V	I_F=0.1mA
Forward voltage	V_F	–	0.29	0.32	V	I_F=1mA
Forward voltage	V_F	–	0.35	0.4	V	I_F=10mA
Forward voltage	V_F	–	0.41	0.5	V	I_F=30mA
Forward voltage	V_F	–	0.52	1	V	I_F=100mA
Reverse Recovery Time	trr	–	–	5	ns	$I_F = I_R$ = 10mA,$I_{R(REC)}$ = 1.0 mA
Repetitive Peak Forward Current	I_{FRM}	–	–	300	mA	
Non–Repetitive Peak Forward	I_{FSM}	–	–	600	mA	(t < 1.0 s)

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ELECTRICAL CHARACTERISTIC CURVES

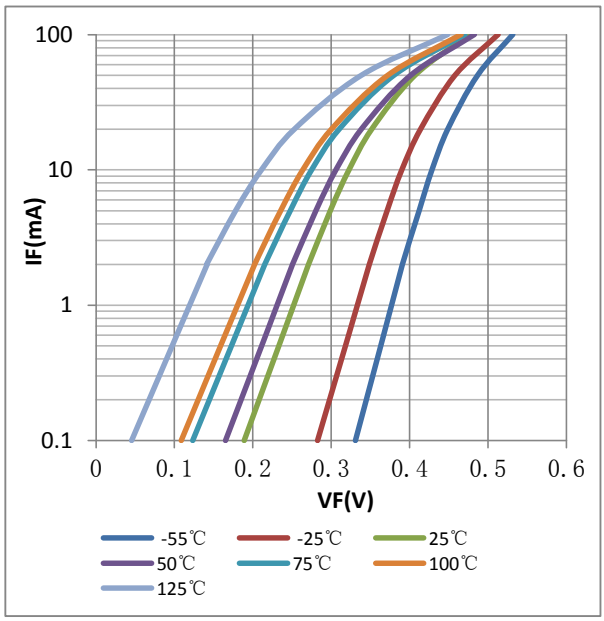

FIG. 1 Forward Characteristics

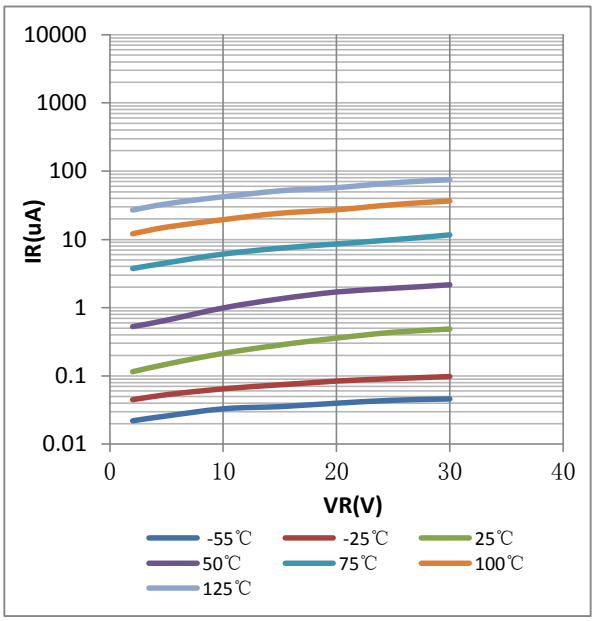

FIG. 2 Reverse Characteristics

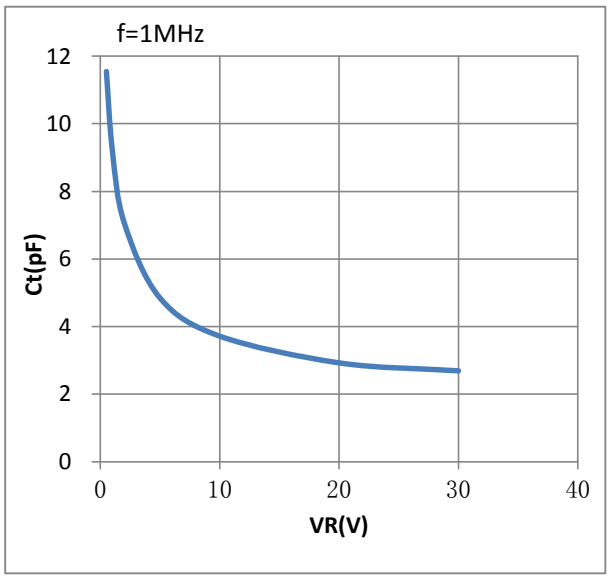

FIG. 3 Capacitance

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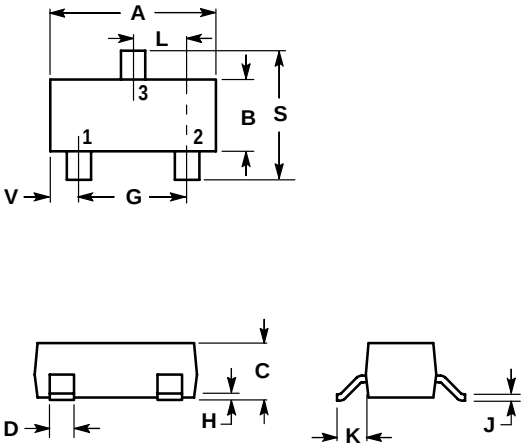
Dimension Outline:



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60

Soldering Footprint: